

Technical Data Sheet

1.8mm round Subminiature Chip LED

42-21A/BHC-ZV1W2N/1T

Features

- Package in 12mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.-
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.
- Pb-free.

Descriptions

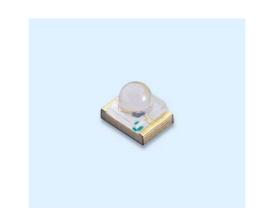
- The 42-21A SMD Taping is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications, etc.

Applications

- Automotive: backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

Device Selection Guide

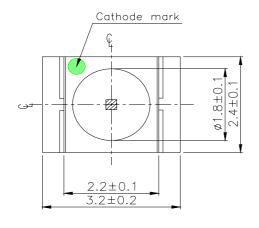
D	Ch		
Part No.	Material	Emitted Color	Lens Color
42-21/BHC-ZV1W2N/1T	InGaN	Blue	Water Clear

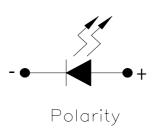


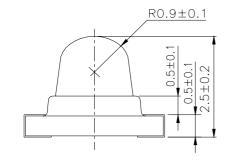
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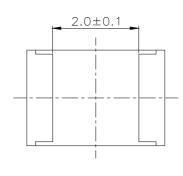
Package Outline Dimensions

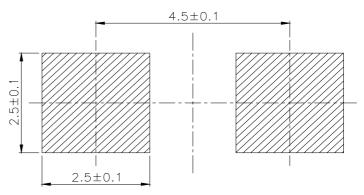












Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

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Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit	
Reverse Voltage	VR	5	V	
Forward Current	IF	25	mA	
Operating Temperature	Topr	-40 ~ +85	$^{\circ}\!\mathbb{C}$	
Storage Temperature	Tstg	-40~ +90	$^{\circ}\!\mathbb{C}$	
Soldering Temperature	Tsol	260 (for 5 second)	$^{\circ}\!\mathbb{C}$	
Electrostatic Discharge	ESD	150	V	
Power Dissipation	Pd	110	mW	
Peak Forward Current (Duty 1/10 @1KHz)	IFP	100	mA	
Soldering Temperature	Tsol	Reflow Soldering: 260 °C for 10 sec. Hand Soldering: 350 °C for 3 sec.		

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	Iv	715		1800	mcd	
Viewing Angle	$2\theta 1/2$		30		deg	
Peak Wavelength	λр		468		nm	
Dominant Wavelength	λd	465		475	nm	I _F =20mA
Spectrum Radiation Bandwidth	Δλ		35		nm	
Forward Voltage	VF	2.65		3.75	V	
Reverse Current	IR			50	μΑ	V _R =5V

Notes:

1. Tolerance of Luminous Intensity ±10%

2.Tolerance of Dominant Wavelength ±1nm

3.Tolerance of Forward Voltage ±0.1V

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Bin Range Of Dom. Wavelength

Group	Bin	Min	Max	Unit	Condition
Z	X	465	470		T 20 1
	Y	470	475	nm	IF=20mA

Bin Range Of Luminous Intensity

Bin	Min	Max	Unit	Condition	
V1	715	900	mcd		
V2	900	1120		IF=20mA	
W1	1120	1420			
W2	1420	1800			

Bin Range Of Forward Voltage

Group	Bin	Min	Max	Unit	Condition
	10	2.65	2.95		
	11	2.85	3.05		
N	12	3.05	3.35	V	IF=20mA
	13	3.25	3.55		
	14	3.45	3.75		

Notes:

1.Tolerance of Luminous Intensity ±10%

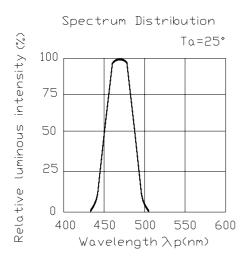
2.Tolerance of Dominant Wavelength ±1nm

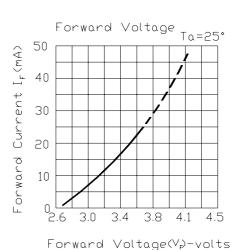
3.Tolerance of Forward Voltage ±0.1V

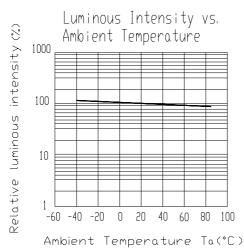
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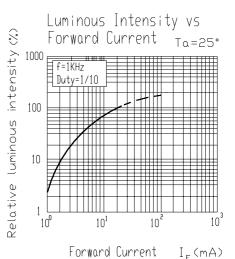
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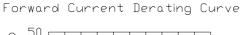
Typical Electro-Optical Characteristics Curves

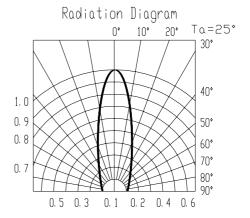


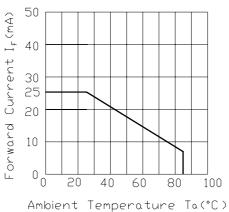












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Label explanation

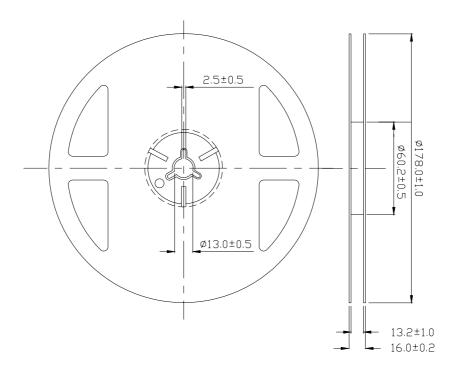
CAT: Luminous Intensity Rank

HUE: Dom. Wavelength Rank

REF: Forward Voltage Rank



Reel Dimensions

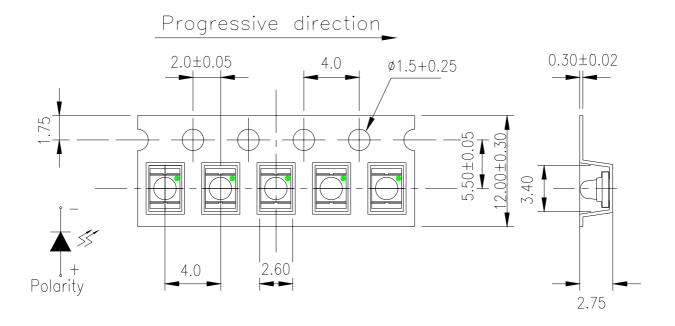


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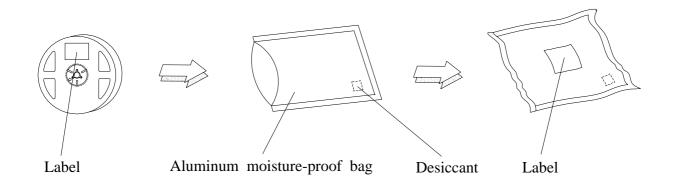
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Carrier Tape Dimensions: Loaded quantity 1000 PCS per reel



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Moisture Resistant Packaging



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Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	$H: +100^{\circ}\mathbb{C}$ 15min $\int 5 \text{ min}$ $L: -40^{\circ}\mathbb{C}$ 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	$H: +100^{\circ}\mathbb{C}$ 5min $\int 10 \sec$ $L: -10^{\circ}\mathbb{C}$ 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°ℂ	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C / 85%RH	1000 Hrs.	22 PCS.	0/1

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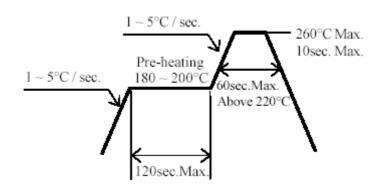
Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package: The LEDs should be kept at 30° C or less and 90%RH or less.
- 2.3 After opening the package: The LEDs should be kept at 30°C or less and 70%RH or less(Floor life). However, it's recommended that the LEDs should be used within 168 hours (7 days) after opening the package. If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions. Baking treatment: $60\pm5^{\circ}$ C for 24 hours.
- 3. Soldering Condition
 - 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

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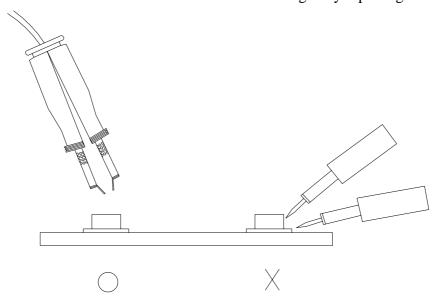


4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350° C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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